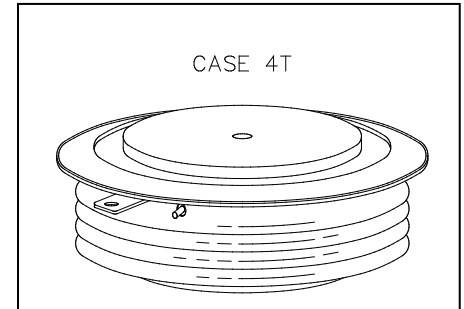


HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

KK1000A2000V C712L

Features:

- . All Diffused Structure
- . Center Amplifying Gate Configuration
- . Blocking capability up to 2100 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

V_{RRM} (1)	V_{DRM} (1)	V_{RSM} (1)
2000	2000	2100

- V_{RRM} = Repetitive peak reverse voltage
 V_{DRM} = Repetitive peak off state voltage
 V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state	I_{RRM} / I_{DRM}	20 mA 90 mA (3)
Critical rate of voltage rise	dV/dt (4)	500 V/ μ sec

Notes:

All ratings are specified for $T_j=25^\circ\text{C}$ unless otherwise stated.

- (1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to $+125^\circ\text{C}$.
- (2) 10 msec. max. pulse width
- (3) Maximum value for $T_j = 125^\circ\text{C}$.
- (4) Minimum value for linear and exponential waveshape to 80% rated V_{DRM} . Gate open. $T_j = 125^\circ\text{C}$.
- (5) Non-repetitive value.
- (6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thristor under test.

Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	$I_{T(AV)}$		1000		A	Sinewave, 180° conduction, $T_c=80^\circ\text{C}$
RMS value of on-state current	I_{TRMS}		1570		A	Nominal value
Peak one cPSTCIE surge (non repetitive) current	I_{TSM}		-		A	8.3 msec (60Hz), sinusoidal wave-shape, 180° conduction, $T_j = 125^\circ\text{C}$
			18500		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, $T_j = 125^\circ\text{C}$
I square t	I^2t		1.66×10^6		A^2s	8.3 msec and 10.0 msec
Latching current	I_L		-		mA	$V_D = 24\text{ V}$; $R_L = 12\text{ ohms}$
Holding current	I_H		-		mA	$V_D = 24\text{ V}$; $I = 2.5\text{ A}$

Peak on-state voltage	V_{TM}		1.45		V	$I_{TM} = 1000 \text{ A}$; Duty Cycle $\leq 0.01\%$; $T_j = 125^\circ\text{C}$
Critical rate of rise of on-state current (5, 6)	di/dt		800		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$, non-repetitive
Critical rate of rise of on-state current (6)	di/dt		200		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$

ELECTRICAL CHARACTERISTICS AND RATINGS
Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P_{GM}		100		W	$t_p = 40 \text{ us}$
Average gate power dissipation	$P_{G(AV)}$		5		W	
Peak gate current	I_{GM}		-		A	
Gate current required to trigger all units	I_{GT}		-		mA	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_j = -40^\circ\text{C}$
			120		mA	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_j = +25^\circ\text{C}$
			-		mA	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_j = +125^\circ\text{C}$
Gate voltage required to trigger all units	V_{GT}		-		V	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_j = -40^\circ\text{C}$
			3.0		V	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_j = 0-125^\circ\text{C}$
			-		V	$V_D = \text{Rated } V_{DRM}$; $R_L = 1000 \text{ ohms}$; $T_j = +125^\circ\text{C}$
Peak negative voltage	V_{GRM}		20		V	

Dynamic

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t_d		-	0.7	μs	$I_{TM} = 50 \text{ A}$; $V_D = \text{Rated } V_{DRM}$ Gate pulse: $V_G = 20 \text{ V}$; $R_G = 20 \text{ ohms}$; $t_r = 0.1 \mu\text{s}$; $t_p = 20 \mu\text{s}$
Turn-off time (with $V_R = -50 \text{ V}$)	t_q		-	50	μs	$I_{TM} = 1000 \text{ A}$; di/dt = 25 A/ μs ; $V_R \geq -50 \text{ V}$; Re-applied dV/dt = 20 V/ μs linear to 80% V_{DRM} ; $V_G = 0$; $T_j = 125^\circ\text{C}$; Duty cPSTCLe $\geq 0.01\%$
Reverse recovery charge	Q_{rr}		*		μC	$I_{TM} = 1000 \text{ A}$; di/dt = 25 A/ μs ; $V_R \geq -50 \text{ V}$

* For guaranteed max. value, contact factory.

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

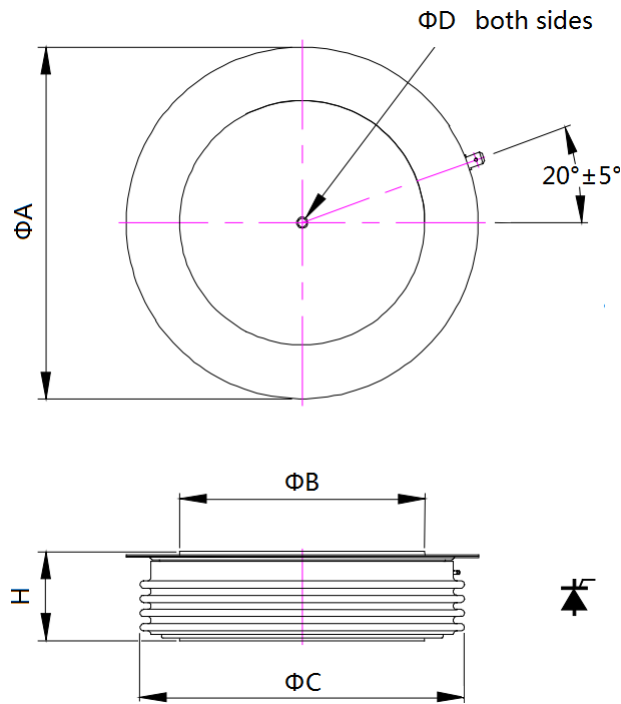
Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T_j	-40	+125		$^\circ\text{C}$	
Storage temperature	T_{stg}	-40	+125		$^\circ\text{C}$	



Thermal resistance - junction to case	$R_{\Theta(j-c)}$		0.023 -		°C/W	Double sided cooled Single sided cooled
Thermal resistance - case to sink	$R_{\Theta(c-s)}$		0.0075 -		°C/W	Double sided cooled * Single sided cooled *
Mounting force	P	22.2	26.6		kN	
Weight	W			-	g	About

* Mounting surfaces smooth, flat and greased

CASE OUTLINE AND DIMENSIONS



Sym	A	B	C	D	H
mm	75	47	66	3.5x3	26±1